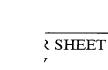
FORM PTO-1594 (Rtv. 6-93)

## 04-16-2001





U.S. DEPARTMENT OF COMMERCE

FORM PTO-1594 (Rev. 6-93)		SHEET %	U.S. DEPARTMENT OF COMMERCE
Atty Docket #: ONS00173	101663		Patent and Trademark Office
To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.			
Name of conveying part(ies):		2. Name and address of receiving party(ies):	
Frantisek Mikulenka			
	2/20/01	Name: Semiconductor Components	Industries, LLC
3. Nature of conveya	· · · · · · · · · · · · · · · · · · ·	Internal Address: Patent Administrati	on Dept A230
		Street Address: 5005 East McDowell	Road
Other		City: Phoenix State: AZ	ZIP: <u>85008</u>
Execution date of conveyance:	January 31, 2001	Additional name(s) & address(es) attached?	Yes 🛭 No
4. Application number(s) or patent number(s):			
If this document is being filed together with a new application is:  A. Patent Application No.(s):		B. Patent No.(s):	75 O
	Additional nu	mbers attached? Yes	No
5. Name and address of party to whom correspondence concerning document should be mailed:		6. Total number of applications and patents involved: 1	
Name:	Semiconductor Components	7. Total fee (37 C.F.R. 3.41)	\$ <u>40.00</u>
Internal Address:	Industries, LLC Patent Administration Dept - MD A230	☐ Enclosed	
Street Address:	P.O. Box 62890	Authorized to be charged to deposit account	
City, State, Zip:	Phoenix, AZ 85082-2890	8. Deposit account number: 501086 (Attach triplicate copy of this page if paying by dep	osit account)
DO NOT USE THIS SPACE			
9. Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.  Robert D. Atkins  Reg. No.  Signature  Total number of pages including cover sheet, attachments, and document: 3			
OMB No. 0651-0011 (exp. 4/94)			
OWR 100 10031-00313 (cxh. 4024)			

00000119 501086 09785750 04/13/2001 GTON11 40.00 CH 01 FC:581

> **PATENT REEL: 011666 FRAME: 0913**

## ASSIGNMENT AND AGREEMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, I, Frantisek Mikulenka of Roznov P/R Czech Republic, have sold, assigned, and transferred, and do hereby sell, assign, and transfer unto Semiconductor Components Industries, LLC (SCI), a corporation of the State of Delaware, having its principal office in Phoenix, State of Arizona, United States of America, and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States of America in and to certain inventions relating to improvements in BIAS STABILIZER CIRCUIT AND METHOD OF OPERATION (Attorney Docket No. ONS00173), described, illustrated, and claimed in an application for Letters Patent of the United States of America executed by me, together with the entire right, title and interest in and to the application, and in and to Letters Patent which may be issued upon the application, and upon any division, extension, continuation, or reissue thereof.

I hereby also sell, assign, and transfer unto SCI, the entire right, title, and interest in and to the invention and in and to applications for Letters Patent therefor in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of the inventions and the applications for Letters Patent in foreign countries, and I further authorize SCI to apply for Letters Patent in foreign countries directly in its own name, and to claim the priority of the filing date of the application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.

I hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America to issue Letters Patent upon the aforesaid application, division, extension, continuation, or reissue, to SCI, for the sole use and behalf of SCI, its successors, assigns, and legal representatives, to the full end of the term for which the Letters Patent may be granted, the same as they would have been held and enjoyed by me had this assignment not been made, and I hereby authorize and request the equivalent authorities in foreign countries to issue the patents of their respective countries to SCI.

I agree that, when requested, I will, without charge to SCI, but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable, or convenient for securing and maintaining patents for the inventions in any and all countries and for vesting title thereto in SCI, its successors, assigns, and legal representatives or nominees.

PATENT REEL: 011666 FRAME: 0914 I covenant with SCI, its successors, assigns, and legal representatives, that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license, or other encumbrance.

Frankite Mikulun

Frankite Mikulun

Date: 31.01. 2001

Witnessed by: Authur Pottyfal

Signature

ANTONIN POZSTPAL

Printed Name

RECORDED: 02/20/2001

Address correspondence concerning this document to: Semiconductor Components Industries, LLC, Patent Administration Dept - MD A230, P.O. Box 62890, Phoenix, AZ 85082-2890.

> PATENT REEL: 011666 FRAME: 0915